

1.Features

- $V_{DS(V)}=30V$
- $I_D=90A(V_{GS}=10V)$
- $R_{DS(ON)}<5.7m\Omega(V_{GS}=10V)$
- $R_{DS(ON)}<7.1m\Omega(V_{GS}=4.5V)$
- Low gate charge (46nC typical)
- High power and current handling capability

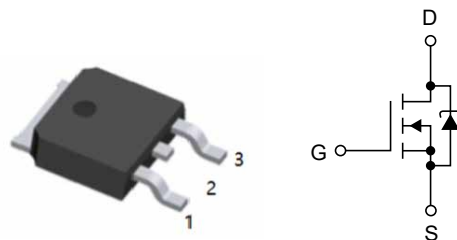
2.Applications

- DC/DC converter
- Low side notebook

3.Pinning information

Pin	Symbol	Description
1	G	GATE
2	D	DRAIN
3	S	SOURCE

TO-252(DPAK)
top view



4.Absolute Maximum Ratings $T_A=25^{\circ}C$

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DSS}	30	V
Gate-Source Voltage	V_{GSS}	± 20	V
Drain Current - Continuous (Note 3)	I_D	90	A
-Pulsed (Note 1a)		100	A
Power Dissipation for Single Operation (Note 1)	P_D	70	W
(Note 1a)		3.1	W
(Note 1b)		1.3	W
Operating and Storage Junction Temperature Range	T_J, T_{STG}	-55 to 150	$^{\circ}C$



5. Thermal Characteristics

Parameter		Symbol	Rating	Units
Thermal Resistance, Junction-to-Case	(Note 1)	$R_{\theta JC}$	1.8	°C/W
Thermal Resistance, Junction-to-Ambient	(Note 1a)	$R_{\theta JA}$	40	°C/W
Thermal Resistance, Junction-to-Ambient	(Note 1b)	$R_{\theta JA}$	96	°C/W



6. Electrical Characteristic ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Drain-Source Avalanche Energy	W_{DSS}	Single Pulse, $V_{DD}=15\text{V}$, $I_D=16\text{A}$		108	250	mJ
Drain-Source Avalanche Current	I_{AR}				16	A
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0\text{V}$, $I_D=1\text{mA}$	30			V
Breakdown Voltage Temperature Coefficient	$\frac{\Delta BV_{DSS}}{\Delta T_J}$	$I_D=10\text{mA}$ Referenced to 25°C		31		mV/ $^\circ\text{C}$
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=24\text{V}$, $V_{GS}=0\text{V}$			500	μA
Gate-Body Leakage	I_{GSS}	$V_{GS}=\pm 20\text{V}$, $V_{DS}=0\text{V}$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_D=1\text{mA}$	1	1.5	3	V
Gate Threshold Voltage Temperature Coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	$I_D=10\text{mA}$ Referenced to 25°C		-3.6		mV/ $^\circ\text{C}$
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}$, $I_D=16\text{A}$		4.7	5.7	m Ω
		$V_{GS}=4.5\text{V}$, $I_D=15\text{A}$		5.8	7.1	m Ω
Forward Transconductance	g_{FS}	$V_{DS}=5\text{V}$, $I_D=16\text{A}$		61		S
Input Capacitance	C_{iss}	$V_{DS}=15\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$		2500		pF
Output Capacitance	C_{oss}			710		pF
Reverse Transfer Capacitance	C_{rss}			270		pF
Gate Resistance	R_g	$V_{GS}=0\text{V}$, $f=1\text{MHz}$		1.6		Ω
Turn-On Delay Time	$t_{D(on)}$	$V_{DD}=15\text{V}$, $I_D=1\text{A}$ $V_{GS}=10\text{V}$, $R_{GEN}=6\Omega$		12	21	ns
Turn-On Rise Time	t_r			12	22	ns
Turn-Off Delay Time	$t_{D(off)}$			46	74	ns
Turn-Off Fall Time	t_f			28	44	ns
Turn-On Delay Time	$t_{D(on)}$	$V_{DD}=15\text{V}$, $I_D=1\text{A}$ $V_{GS}=4.5\text{V}$, $R_{GEN}=6\Omega$		20	32	ns
Turn-On Rise Time	t_r			24	38	ns
Turn-Off Delay Time	$t_{D(off)}$			35	56	ns
Turn-Off Fall Time	t_f			27	43	ns

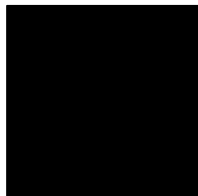


Total Gate Charge, $V_{GS}=10V$	$Q_{g(TOT)}$	$V_{DS}=15V, I_D=16A$		46	64	nC
Total Gate Charge, $V_{GS}=5V$	Q_g			25	35	nC
Gate–Source Charge	Q_{gs}			7		nC
Gate–Drain Charge	Q_{gd}			9		nC
Maximum Continuous Drain–Source Diode Forward Current	I_S				3.5	A
Drain–Source Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=3.5A$ (Note 2)		0.4	0.7	V
Diode Reverse Recovery Time	t_{rr}	$dI/dt=300A/\mu s, I_F=16A$		25		ns
Maximum Recovery Current	I_{RM}			1.9		A
Diode Reverse Recovery Charge	Q_{rr}			24		nC

Notes:

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.

$R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) $R_{\theta JA}=40^{\circ}C/W$ when mounted
on a 1in² pad of 2oz copper.



b) $R_{\theta JA}= 96^{\circ}C/W$ when mounted
on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μs , Duty Cycle < 2.0%

3. Maximum current is calculated as: $\sqrt{\frac{P_D}{R_{DS(ON)}}}$

where P_D is maximum power dissipation at $T_C=25^{\circ}C$ and $R_{DS(ON)}$ is at $T_{J(max)}$ and $V_{GS}=10V$. Package current limitation is 21A.



7.1 Typical characteristic

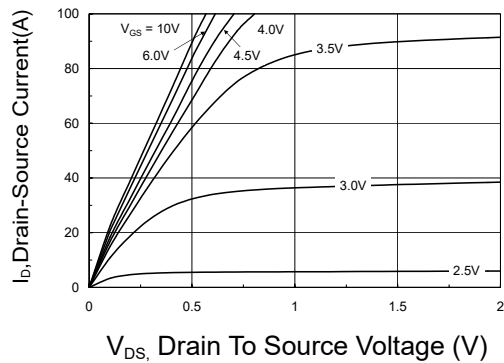


Figure 1: On-Region Characteristics

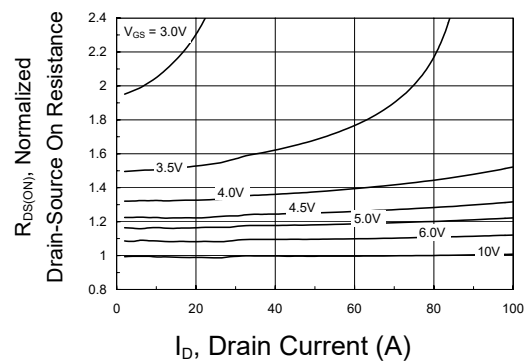


Figure 2: On-Resistance Variation with Drain Current and Gate Voltage

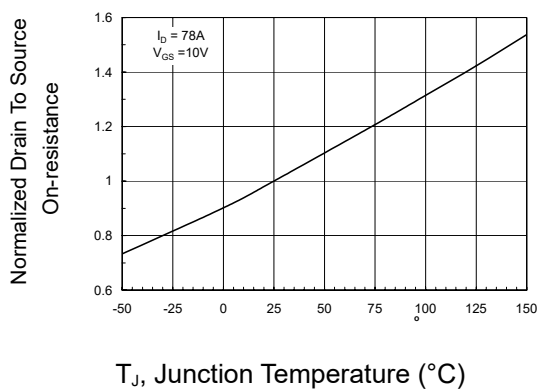


Figure 3: On-Resistance Variation with Temperature

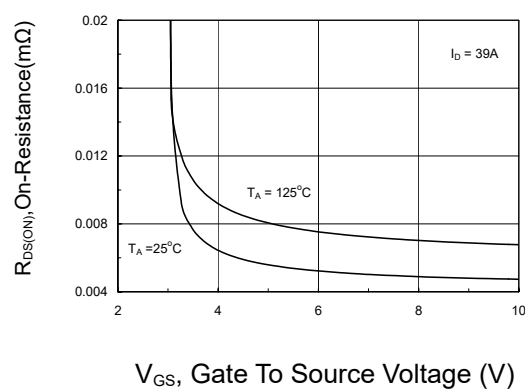


Figure 4: On-Resistance Variation with Gate-to-Source Voltage

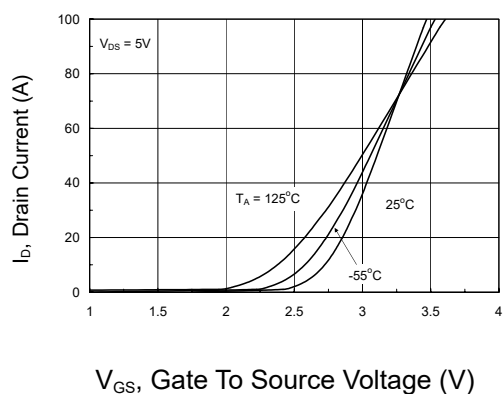


Figure 5: Transfer Characteristics

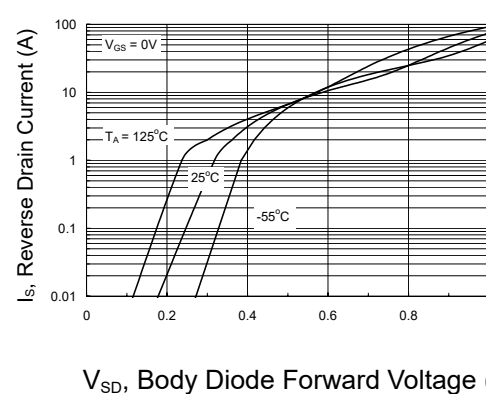


Figure 6: Body Diode Forward Voltage Variation with Source Current and Temperature



7.2 Typical characteristic

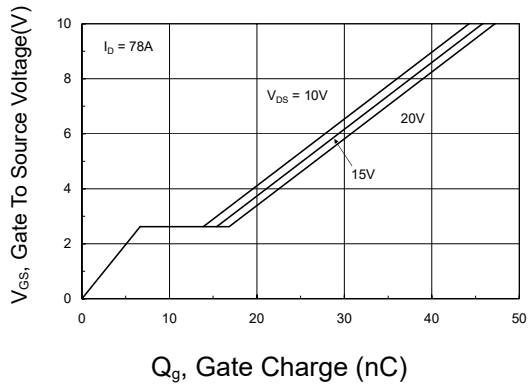


Figure 7: Gate Charge Characteristics

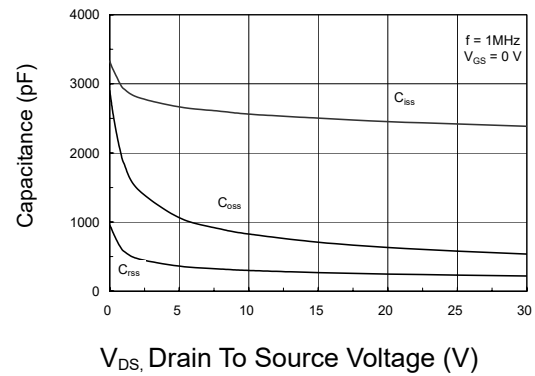


Figure 8: Capacitance Characteristics

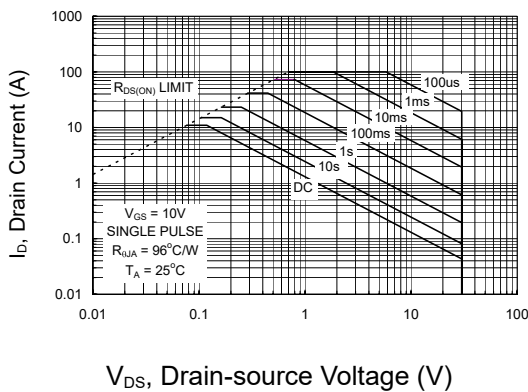


Figure 9: Maximum Safe Operating Area

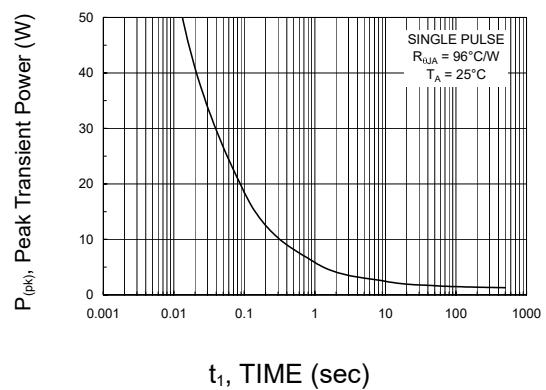


Figure 10: Single Pulse Maximum Power Dissipation

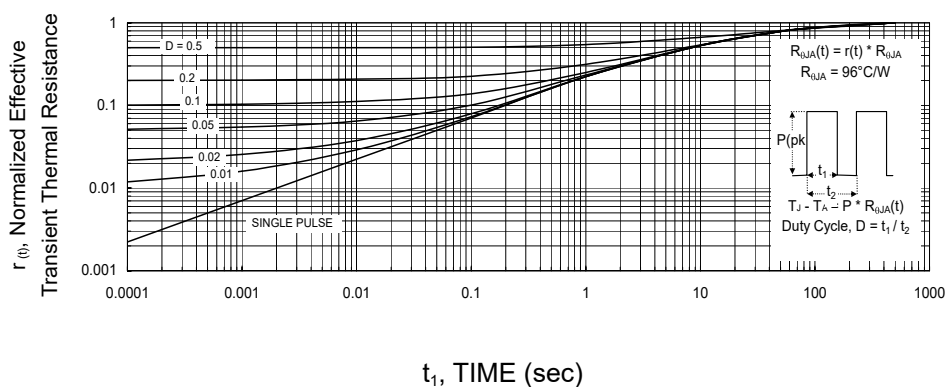
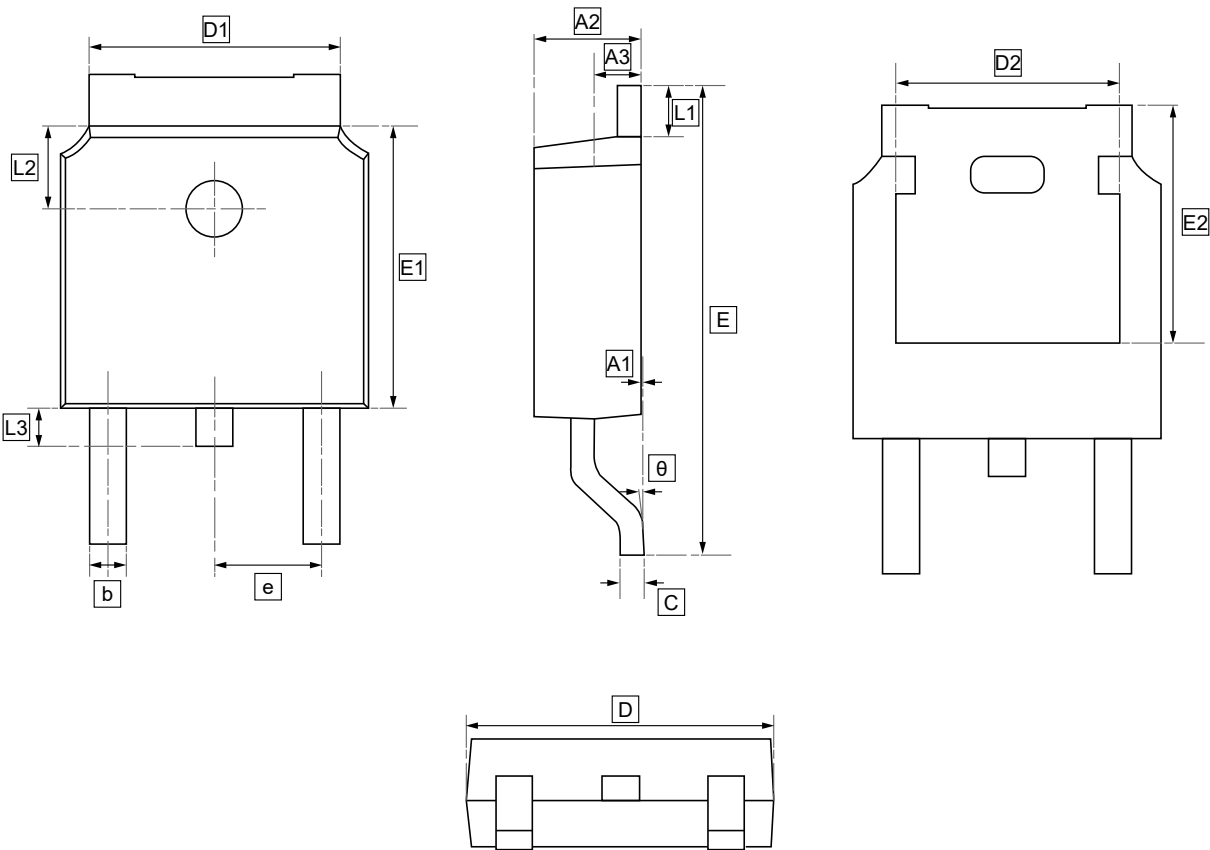


Figure 11: Transient Thermal Response Curve



8.TO-252 Package Outline Dimensions

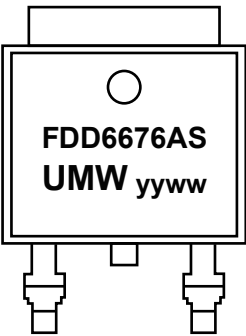


DIMENSIONS (mm are the original dimensions)

Symbol	A1	A2	A3	b	c	D	D1	D2	E	E1	E2	e	L1	L2	L3	θ
Min	0.00	2.18	0.90	0.65	0.46	6.35	4.95	4.32	9.40	5.97	5.21	2.286	0.89	1.70	0.60	0.00
Max	0.13	2.39	1.10	0.85	0.61	6.73	5.46	4.90	10.41	6.22	5.38		1.27	1.90	1.00	8.00



9.Ordering information



yy: Year Code
ww: Week Code

Order Code	Package	Base QTY	Delivery Mode
UMW FDD6676AS	TO-252	2500	Tape and reel



10.Disclaimer

UMW reserves the right to make changes to all products, specifications. Customers should obtain the latest version of product documentation and verify the completeness and currency of the information before placing an order.

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